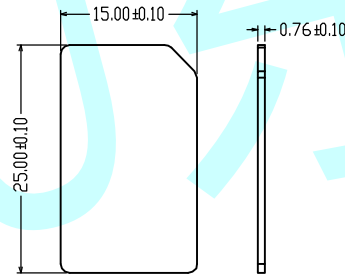
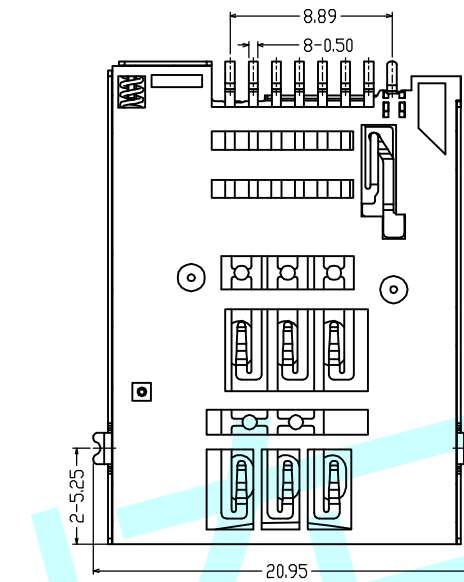
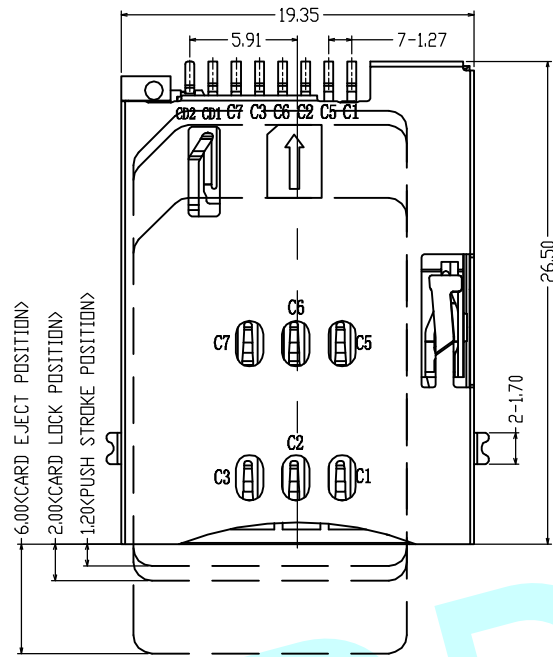
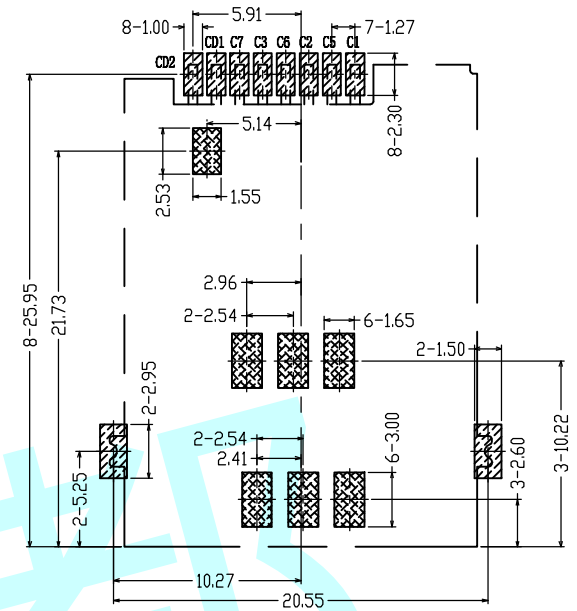


ROHS



SC :2;1



RECOMMENDED PCB LAYOUT
TOLERANCE: ±0.05

- SMT SOLDER AREA
- COPPER RESTRICTED AREA
 1. TOUCH AREA OF CONTACT TIPS NO ELECTRICAL FUNCTION
 2. NO FIRST PCB LAYOUT CIRCUITS IN THE AREA

NOTES:

A. Material:

1. Housing: High Temperature Thermoplastic
2. Terminal: Copper Alloy
3. Shell: Stainless Steel

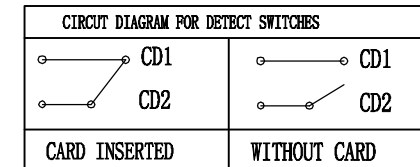
B. Plating:

1. Terminal: 50u" Ni Underplated Overall
2. G/F Plated On Contact Area
3. Matte Tin Plated On Solder Area
4. Shell: 30u" Ni Underplated Overall
5. G/F Plated On Contact Area And Solder Area

C. Technical Speciality:

1. Rated Voltage: 30V
2. Current Rating: 0.5A
3. Insulation Resistance: 1000MΩ Min
4. Contact Resistance: 100mΩ Max
5. Withstanding Voltage: 500V DC For 1 Minutes
6. Operating Temperature: -40°C ~ +75°C Humidity 80% R.H Max.

PIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
CD1	POL
CD2	Detect Switch



APPROVALS		DATE	http://www.dongdudz.com	
DRAW:	ZRD	2017-12-6	TOLERANCE:	ANGLE:
CHECKED:	***	****	30≥	±0.30
			10~30	±0.20
			5~10	±0.15
APPOVALS:	***	****	≤5	±0.10

东都电子	
DONGDU ELECTRONICS	
MODL:	CASSETTE
PART NO:	SIM-8P-H1. 8-123
UNIT :mm	SCALE: 1:1
REV:	A